## 504400192 06/06/2017

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HIROKI KAWADA	04/19/2017
MUNEYUKI FUKUDA	04/19/2017
YOSHINORI MOMONOI	04/19/2017
SHOU TAKAMI	04/19/2017

### **RECEIVING PARTY DATA**

Name:	HITACHI HIGH-TECHNOLOGIES CORPORATION	
Street Address:	Address: 24-14, NISHI SHIMBASHI 1-CHOME	
City:	MINATO-KU, TOKYO	
State/Country:	JAPAN	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15533489

#### CORRESPONDENCE DATA

**Fax Number:** (202)628-8844

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 2026242500

Email: elawson@crowell.com

Correspondent Name: CROWELL & MORING LLP

Address Line 1: 1001 PENNSYLVANIA AVENUE, N.W.

Address Line 4: WASHINGTON, D.C. 20004

ATTORNEY DOCKET NUMBER:	R: 104349.PA005US	
NAME OF SUBMITTER: MICHAEL H. JACOBS		
SIGNATURE: /Michael H. Jacobs/		
DATE SIGNED:	06/06/2017	

**Total Attachments: 1** 

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PATENT 504400192 REEL: 042618 FRAME: 0013

# ASSIGNMENT

(瀬渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan, located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

#### HEIGHT MEASUREMENT DEVICE AND CHARGED PARTICLE BEAM DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, PCT/JP2014/082610 filed December 10, 2014, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted.

to be held and enjoyed by said. HITACHI HIGH-TECHNOLOGIES CORPORATION,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION.

Signed on the date(s) indicated aside our signatures:

	MVENTOR(S) (後男者フルネームサイン)	Date Signed (署名 E)
1)	Winch Kawada HIROHIKAWADA	4/19/2017
2)	Municipali Frekuda Munoyuki FUKUDA	4/19/2017
	Joseph Memory Yeshinori MOMONO!	April 19, 2017
	Show Takami Show TAKAMI	4/19/2017
5)		*
6)		
7)		
8)		<u>,</u>
9)		·
10)		

PATENT REEL: 042618 FRAME: 0014

RECORDED: 06/06/2017